

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Texas Instruments RI-TH1-CB1A-00

For any questions, you can email us directly: sales@integrated-circuit.com



Distributor of Texas Instruments: Excellent Integrated System LimitedDatasheet of RI-TH1-CB1A-00 - RFID TRANSPNDR VICINITY 13.56MHZ

Contact us: sales@integrated_bisolete@peViceite: www.integrated-circuit.com



RADIO FREQUENCY IDENTIFICATION SYSTEMS

13.56 MHz Vicinity Card Transponder



Key features:

- IS0/IEC 15693 compliant
- 13.56MHz Operating Frequency
- Read/Write capability with data locking option
- 2k bit user memory
- Simultaneous Identification

The Vicinity Card Transponder from Texas Instruments is compliant with the ISO/IEC 15693 global standard for contactless integrated circuit cards operating at 13.56MHz. The card is based on TI's Tag-it™ Smart Label technology and allows interoperability of products from multiple manufacturers. With a user memory of 2K bits organized in 64 blocks, the 13.56 MHz card enables advanced solutions in a variety of markets, including access control, security, ticketing, public transportation, production control, warehouse management etc.. This card can be easily customized and personalized using standard thermo transfer printers. In applications where the card needs to be used with a clip, we recommend a pouch since punching a hole would destroy the product. In addition to the functionality defined in the ISO/IEC 15693 standard, the Vicinity Card Transponder also supports an extended set of command options, providing more system flexibility.

Specifications:

Part Number	RI-TH1-CB1A					
Supported Standard	ISO 15693					
Operating frequency	13.56 MHz					
Typ. required activation field strength read (at +25°C)	94 dBμA/m					
Typ. required activation field strength write (at +25°C)	97 dBμA/m					
Factory programmed Read Only Number	64 bits					
Memory (user programmable)	2k bits organized in 64 x 32-bit blocks					
Typical programming cycles (at +25°C)	100,000					
Data retention time (at +55°C)	> 10 years					
Simultaneous Identification of Tags	Up to 50 tags per second (reader/antenna dependent)					
Dimensions	85.6 mm x 54 mm x 0.76mm (according ISO 7810)					
Weight	5 grams					
Case material	PVC (Polyvinylchloride), white					
Product Identifier	3mm from the edge, TI Logo + 4 digit number (2 mm x 8 mm)					
Surface finish	Glossy					
Printability	Thermotransfer, Tampon, Silkscreen					
Mechanical Stability (Bending, Torsion)	According to ISO 10373					
Operating temperature	-25°C to +50°C (according to ISO7810)					
Storage temperature	-25°C to +50°C (according to ISO 7810)					
Packing quantity	250 unit					

Note: For highest possible read-out coverage we recommend to operate readers at a modulation depth of 20% or higher

For more information, contact the sales office or distributor nearest you. This contact information can be found on our web site at: http://www.ti-rfid.com

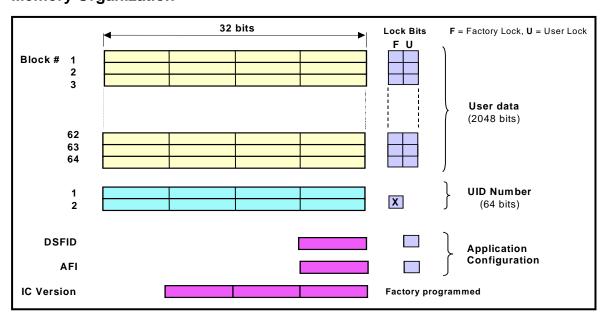


Supported Command Set

		Request Mode						
Request	Request Code	Inventory	Addressed	Non- Addressed	Select	AFI		
ISO 15693 Mandatory and Optional Commands								
Inventory	0x01	✓	-	-	-	✓		
Stay Quiet	0x02	-	✓	-	-	-		
Read_Single_Block	0x20	✓	✓	✓	✓	✓		
Write_Single_Block	0x21	-	✓	√	√	-		
Lock_Block	0x22	-	✓	✓	√	-		
Read_Multi_Blocks	0x23	✓	✓	✓	✓	✓		
Write_Multi_Blocks	0x24	-	-	-	-	-		
Select Tag	0x25	-	✓	-	-	-		
Reset to Ready	0x26	-	✓	√	√	-		
Write_AFI	0x27	-	✓	✓	✓	-		
Lock_AFI	0x28	1	√	\	\	•		
Write DSFID	0x29	-	✓	√	√	-		
Lock DSFID	0x2A	-	✓	✓	✓	-		
Get_System_info	0x2B	√	✓	✓	√	√		
Get_M_Blk_Sec_St	0x2C	✓	√	✓	√	√		
TI Custom Commands								
Write_2_Blocks	0xA2	-	√	✓	✓	-		
Lock_2_Blocks	0xA3	-	√	✓	✓	-		

✓: Implemented-: Not applicable

Memory Organization



Texas Instruments reserves the right to change its products and services at any time without notice. TI provides customer assistance in various technical areas, but does not have full access to data concerning the uses and applications of customers products. Therefore, TI assumes no responsibility for customer product design or for infringement of patents and/or the rights of third parties, which may result from assistance provided by TI.



Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of RI-TH1-CB1A-00 - RFID TRANSPNDR VICINITY 13.56MHZ

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

5-May-2015

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
RI-TH1-CB1A-00	OBSOLETE	RFIDP	TEH	0		TBD	Call TI	Call TI			

PACKAGING INFORMATION

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Addendum-Page 1



Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of RI-TH1-CB1A-00 - RFID TRANSPNDR VICINITY 13.56MHZ

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical

Security Power Mgmt Space, Avionics and Defense www.ti.com/space-avionics-defense power.ti.com

www.ti.com/security

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

Products

Logic

OMAP Applications Processors TI E2E Community www.ti.com/omap e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

logic.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated